



Dual N-Channel 30 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|---|---------------------------------|-----------------------|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) ^a | Q _g (Typ.) | |
| 30 | $0.225 \text{ at V}_{GS} = 4.5 \text{ V}$ | 1.3 ^a | 1.15 nC | |
| | 0.345 at $V_{GS} = 2.5 \text{ V}$ | 1.3 ^a | 1.15110 | |

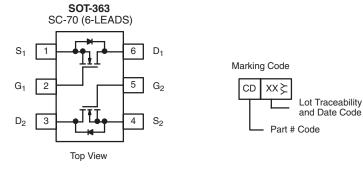
FEATURES

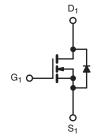
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

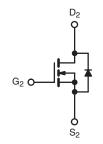


APPLICATIONS

• Load Switch for Portable Applications







Ordering Information: Si1970DH-T1-E3 (Lead (Pb)-free)

Si1970DH-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET N-Channel MOSFET

| Parameter | Symbol | Limit | Unit | | |
|--|-----------------------------------|-----------------|----------------------|----|--|
| Drain-Source Voltage | V _{DS} | 30 | V | | |
| Gate-Source Voltage | V _{GS} | ± 12 | | | |
| | T _C = 25 °C | | 1.3 ^a | | |
| Continuous Proin Current /T 150 °C) | T _C = 70 °C | | 1.3 ^a | | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | I _D | 1.3 ^a | | |
| | T _A = 70 °C | | 1.1 | A | |
| Pulsed Drain Current | | I _{DM} | 4 | 7 | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | 1 | 1.0 | | |
| Continuous Source-Diam Diode Current | T _A = 25 °C | I _S | 0.61 ^c | | |
| | T _C = 25 °C | | 1.25 | | |
| Maximum Power Dissipation | T _C = 70 °C | P _D | 0.8 | w | |
| Maximum Fower Dissipation | T _A = 25 °C | r _D | 0.74 ^{b, c} | VV | |
| | T _A = 70 °C | | 0.47 ^{b, c} | | |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | - 55 to 150 | °C | | |
| Soldering Recommendations (Peak Temperature | | 260 | | | |

Lot Traceability

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{b, f} | t ≤ 5 s | R _{thJA} | 130 | 170 | °C/W | |
| Maximum Junction-to-Foot (Drain) | Steady State | R_{thJF} | 80 | 100 | | |

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 220 °C/W.

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| SPECIFICATIONS T _J = 25 °C, unless otherwise noted | | | | | | | | |
|--|-------------------------|---|------|-------|-------|-------|--|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | | |
| Static | | | | • | | • | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0 \text{ V, I}_{D} = 250 \mu\text{A}$ | 30 | | | V | | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | J 050 A | | 25 | | mV/°C | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | | - 3.2 | | | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 0.6 | | 1.6 | V | | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$ | | | ± 100 | ns | | |
| Zana Oaka Valkana Danin Oamani | I _{DSS} | V _{DS} = 30 V, V _{GS} = 0 V | | | 1 | μА | | |
| Zero Gate Voltage Drain Current | | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$ | | | 10 | | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ | 4 | | | Α | | |
| Drain Course On State Resistance | Б | $V_{GS} = 4.5 \text{ V}, I_D = 1.2 \text{ A}$ | | 0.185 | 0.225 | | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 2.5 \text{ V}, I_D = 0.29 \text{ A}$ | | 0.285 | 0.345 | Ω | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 1.2 A | | 2.5 | | S | | |
| Dynamic ^b | | | | • | | • | | |
| Input Capacitance | C _{iss} | | | 95 | | pF | | |
| Output Capacitance | C _{oss} | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 17 | | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 9 | | | | |
| Total Cata Charge | Qg | V _{DS} = 15 V, V _{GS} = 10 V, I _D = 1.4 A | | 2.5 | 3.8 | nC | | |
| Total Gate Charge | | | | 1.15 | 1.7 | | | |
| Gate-Source Charge | | $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 1.4 \text{ A}$ | | 0.4 | | | | |
| Gate-Drain Charge | Q_{gd} | | | 0.3 | | | | |
| Gate Resistance | R_{g} | f = 1 MHz | | 4 | | Ω | | |
| Turn-On Delay Time | t _{d(on)} | | | 9 | 15 | ns | | |
| Rise Time | t _r | $V_{DD} = 15 \text{ V}, R_{L} = 13.6 \Omega$ | | 20 | 30 | | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 1.1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$ | | 15 | 25 | | | |
| Fall Time | t _f | | | 15 | 25 | | | |
| Turn-on Delay Time | t _{d(on)} | | | 5 | 10 | | | |
| Rise Time | t _r | V_{DD} = 15 V, R_L = 13.6 Ω | | 10 | 15 | | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 1.1 \text{ A}, V_{GE}N = 10 \text{ V}, R_g = 1 \Omega$ | | 10 | 15 | | | |
| Fall Time | t _r | | | 6 | 12 | | | |
| Drain-Source Body Diode Characteristic | s | | | | | | | |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | | | 1 | Α | | |
| Pulse Diode Forward Current | I _{SM} | | | | 4 | | | |
| Body Diode Voltage | V_{SD} | I _S = 1.1 A, V _{GS} = 0 V | | 0.85 | 1.2 | V | | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 20 | 40 | ns | | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 10 | 20 | nC | | |
| Reverse Recovery Fall Time | t _a | $I_F = 1.1 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$ | | 16.5 | | ns | | |
| Reverse Recovery Rise Time | t _b | | | 3.5 | | | | |

Notes:

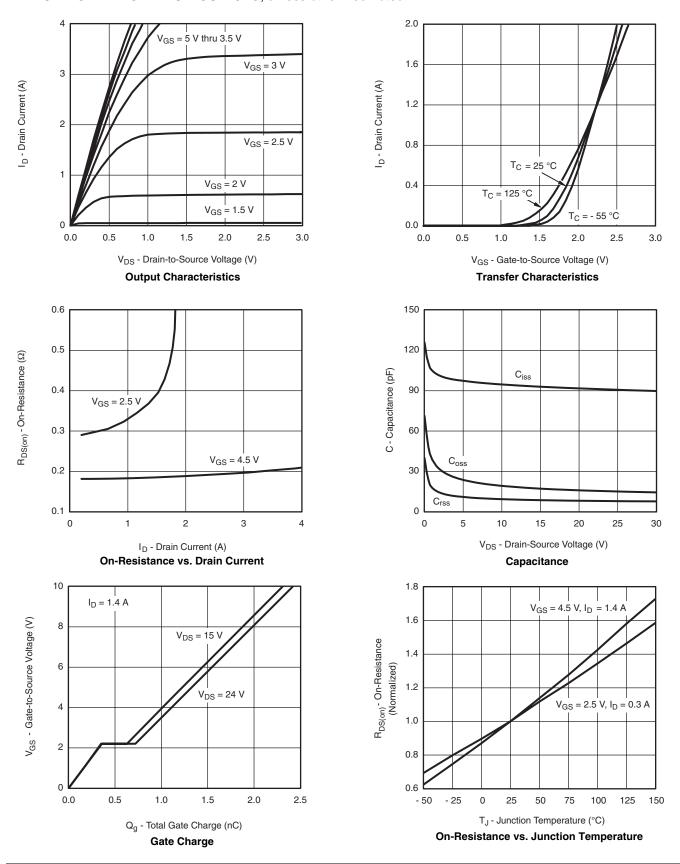
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



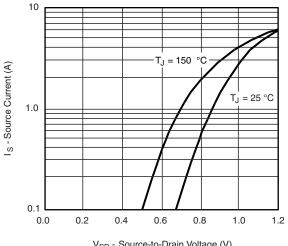


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

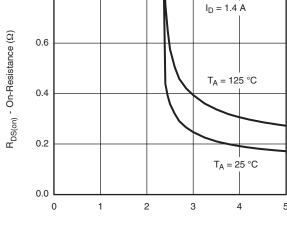


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



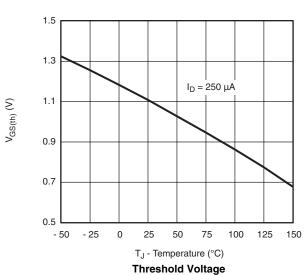
V_{SD} - Source-to-Drain Voltage (V)



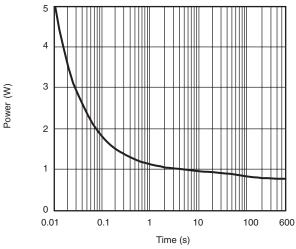
0.8

V_{GS} - Gate-to-Source Voltage (V)

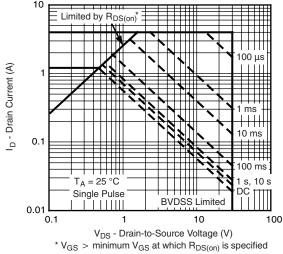




On-Resistance vs. Gate-Source Voltage



Single Pulse Power

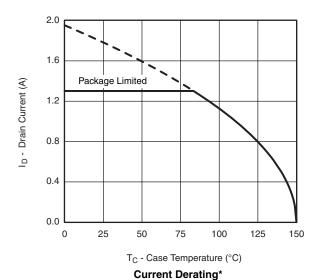


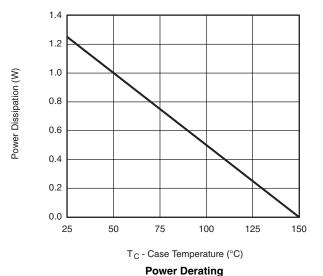
Safe Operating Area, Junction-to-Ambient





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



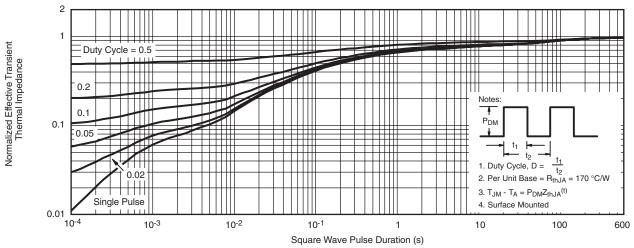


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

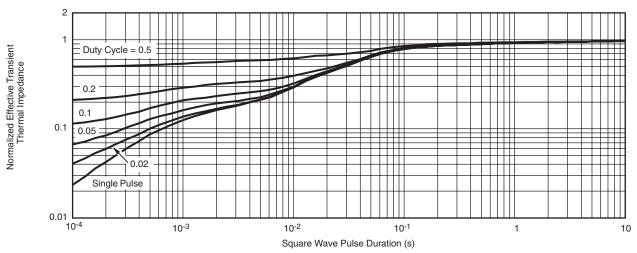
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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